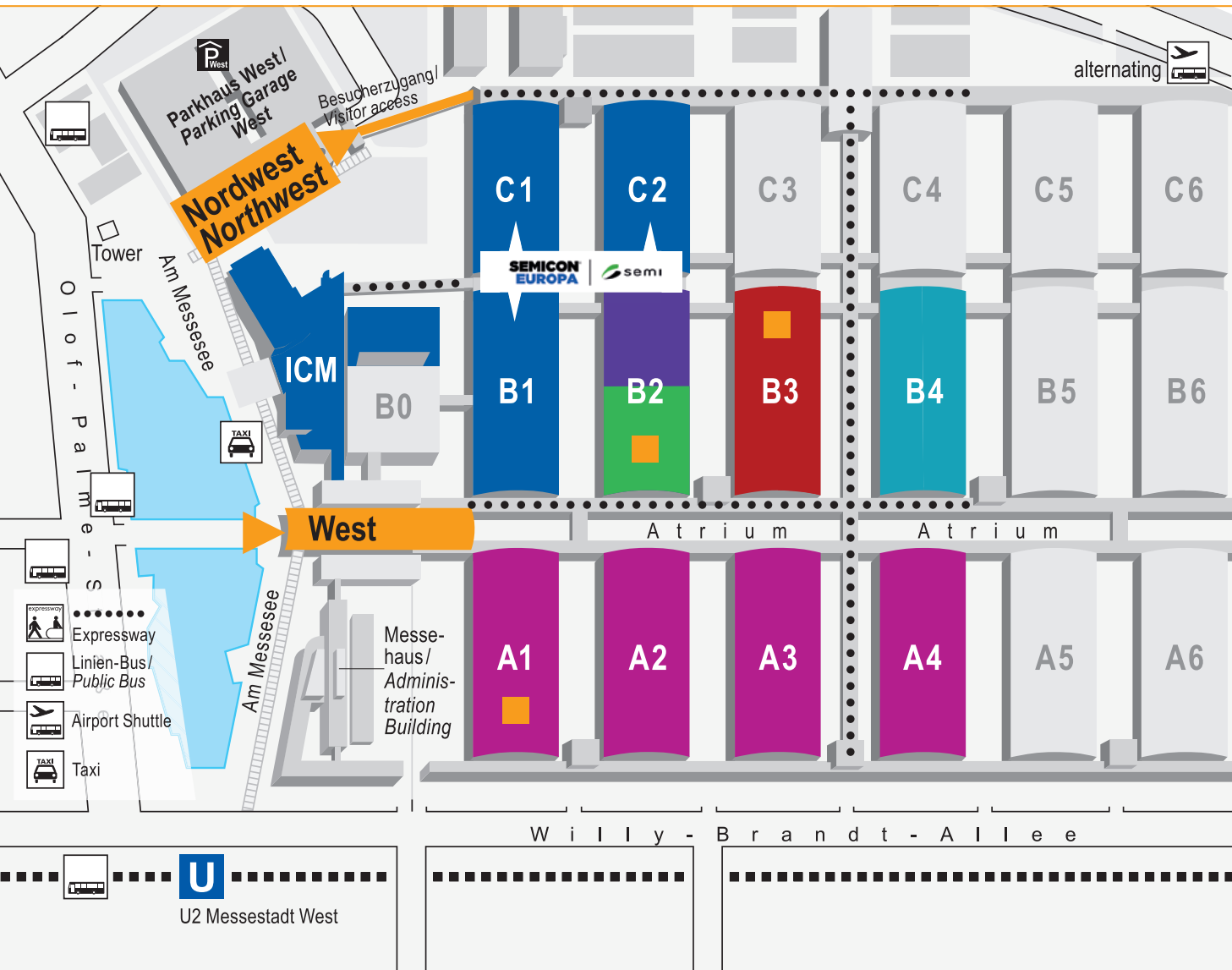








Plan of the fair grounds and exhibition areas 2025



A1	SMT Cluster Test and measurement, quality assurance productronica Forum	
A2	SMT Cluster Test and measurement, quality assurance Component mount technology Production logistics and material-flow technology	
A3	SMT Cluster Component mount technology	
A4	SMT Cluster Soldering and joining technology for PCBs Product finishing	
ICM+B1 C1+C2	SEMICON Europa 2025 November 18-21, 2025	 
B2	Semiconductors Cluster Semiconductor production Production of displays, LEDs and discretes Photovoltaics production micronano-production / MEMS Clean room technology Materials processing	
B2	Future Markets Cluster IT to Production, Industry 4.0 Production technologies for batteries and electrical energy storage Organic and printed electronics 3D Printing, Additive Manufacturing Innovation Forum	
B3	PCB & EMS Cluster PCB and circuit-carrier manufacturing Electronic Manufacturing Services (EMS) PCB & EMS Marketplace	
B4	Cables, Coils and Hybrids Cluster Production technologies for cables and connectors, Coilware production Hybrid-component manufacturing	